

# **☆TDK** Multilayer Ceramic Chip Capacitors

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Creation Date: May 06, 2014

# C1608X7R2A102K080AA (TDK item description: C1608X7R2A102KT\*\*\*\*)

**Applications** 



Commercial Grade



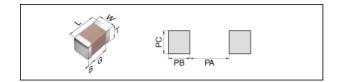
Please refer to Part No. CGA3E2X7R2A102K080AA for automotive use.

Feature

Mid Voltage (100 to 630V)

Series

C1608 [EIA CC0603]











Size		
Length(L)	1.60mm +/-0.10mm	
Width(W)	0.80mm +/-0.10mm	
Thickness(T)	0.80mm +/-0.10mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)	0.30mm Min.	
Recommended Land Pattern(PA)	0.70 to 1.00mm (Flow Soldering) br />0.60 to 0.80mm (I	Reflow Soldering)
Recommended Land Pattern(PB)	0.80 to 1.00mm (Flow Soldering) br />0.60 to 0.80mm (I	Reflow Soldering)
Recommended Land Pattern(PC)	0.60 to 0.80mm (Flow Soldering) br />0.60 to 0.80mm (I	Reflow Soldering)
Recommended Slit Pattern(SD)		

Electrical Characteristics		
Capacitance	1nF +/-10%	
Rated Voltage	100Vdc	
Temperature Characteristic	X7R(+/-15%)	
Dissipation Factor	3% Max.	
Insulation Resistance	10000MΩ Min.	

Other		
Soldering Method	Reflow, Flow	
AEC Q200	No	
Packing	Punched (Paper)Taping [180mm Reel]	
Package Quantity	4000Pcs Min.	

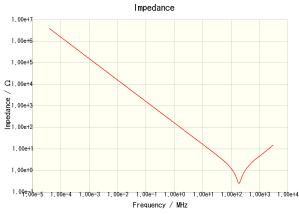
<sup>•</sup>This PDF document was created based on the data listed on the TDK Corporation website.

<sup>•</sup>All specifications are subject to change without notice.

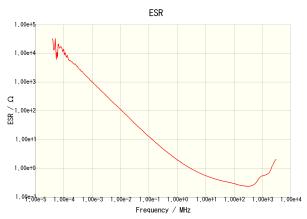
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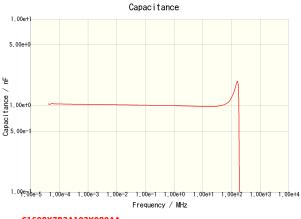
## Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)



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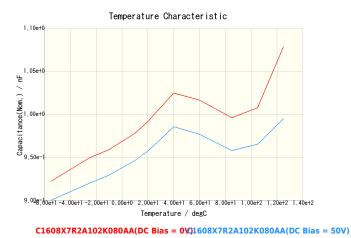
C1608X7R2A102K080AA

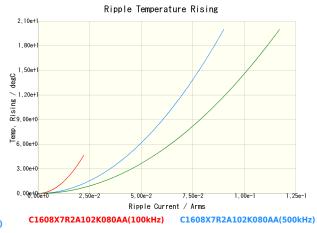


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C1608X7R2A102K080AA





C1608X7R2A102K080AA(1MHz)

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